

# Contents

<b>1</b>	<b>Introduction</b>	<b>1</b>
1.1	Physics Objectives . . . . .	1
1.2	CMS Tracker Performance . . . . .	3
1.3	Overview and Layout of the CMS Tracking System . . . . .	4
1.4	Progress Since the Technical Proposal . . . . .	9
1.5	Tracker Material Budget . . . . .	10
1.6	Staged Deployment of the CMS Tracker . . . . .	11
1.7	The LHC Radiation Environment . . . . .	12
<b>2</b>	<b>The Pixel Detector System</b>	<b>13</b>
2.1	Overview and Requirements . . . . .	13
2.2	Experimental Constraints and Layout . . . . .	15
2.2.1	Design constraints . . . . .	15
2.2.2	Pixel size and shape . . . . .	15
2.2.3	Pixel system layout . . . . .	17
2.2.3.1	Pixel barrel layout . . . . .	17
2.2.3.2	End disk layout . . . . .	19
2.3	Pixel Sensors . . . . .	20
2.3.1	Choice of detector material . . . . .	20
2.3.2	Performance of irradiated silicon pixel detectors . . . . .	20
2.3.3	Specification of sensors . . . . .	23
2.3.4	Layout of sensors . . . . .	25
2.3.4.1	Barrel sensors . . . . .	25
2.3.4.2	The end disk sensors . . . . .	25
2.4	Pixel Readout Electronics . . . . .	27
2.4.1	Overview . . . . .	27
2.4.2	Simulation of experimental conditions . . . . .	28
2.4.2.1	Expected hit rates . . . . .	29
2.4.2.2	Analog readout and threshold effects . . . . .	30
2.4.3	Radiation-hard processes . . . . .	32
2.4.4	Analog front-end . . . . .	32
2.4.4.1	Design considerations . . . . .	32
2.4.4.2	Conceptual design of the pixel analog block . . . . .	33
2.4.4.3	Radiation-hard prototype analog chips . . . . .	35
2.4.4.4	Conclusions . . . . .	42
2.4.5	Readout architecture . . . . .	43
2.4.5.1	Column drain architecture . . . . .	43
2.4.5.2	Simulations of architecture performance . . . . .	44
2.4.5.3	Pixel unit cell design . . . . .	48

---

2.4.5.4	Column periphery design . . . . .	49
2.4.5.5	Radiation-hard prototype readout chips . . . . .	51
2.4.5.6	Data transmission . . . . .	55
2.4.5.7	Front-end system set-up, control and monitoring . . . . .	60
2.4.6	Conceptual design of full pixel readout chip . . . . .	61
2.4.7	Low voltage power and bias voltage distribution . . . . .	63
2.5	Modules . . . . .	63
2.5.1	Barrel module . . . . .	64
2.5.2	The end disk blades . . . . .	65
2.5.3	Bump bonding . . . . .	66
2.5.3.1	Introduction . . . . .	66
2.5.3.2	Technology considerations . . . . .	66
2.5.3.3	Current research . . . . .	67
2.5.3.4	Conclusion and future direction . . . . .	68
2.5.4	Assembly and tests . . . . .	68
2.6	Mechanics . . . . .	69
2.6.1	Requirements . . . . .	69
2.6.2	Barrel mechanical frame . . . . .	69
2.6.3	The mechanical concept of the end disks . . . . .	70
2.6.3.1	The blade . . . . .	70
2.6.3.2	The disk . . . . .	72
2.6.3.3	The space frame . . . . .	73
2.6.4	Cooling . . . . .	74
2.7	Pixel Services and Installation . . . . .	75
2.8	Alignment . . . . .	77
2.9	Appendix . . . . .	78
2.9.1	Radiation hardness of gallium arsenide . . . . .	78
2.9.2	Radiation hardness of diamond . . . . .	79
<b>3</b>	<b>The Silicon Strip Tracker</b> . . . . .	<b>81</b>
3.1	Introduction . . . . .	81
3.2	Overview and Requirements . . . . .	81
3.2.1	Overview . . . . .	81
3.2.2	Requirements . . . . .	83
3.2.2.1	Pattern recognition and momentum measurement . . . . .	83
3.2.2.2	Tracking efficiency and vertex capability . . . . .	84
3.2.2.3	Lifetime . . . . .	84
3.3	Experimental Constraints and Layout . . . . .	85
3.3.1	Experimental constraints . . . . .	85
3.3.1.1	The radiation environment . . . . .	85
3.3.1.2	Low mass and high mechanical stability . . . . .	85
3.3.1.3	Size and complexity . . . . .	86
3.3.2	Design choices . . . . .	86
3.3.2.1	Detectors . . . . .	86
3.3.2.2	Read-out electronics . . . . .	86
3.3.2.3	Modules . . . . .	87
3.3.2.4	Mechanical structure . . . . .	87
3.3.2.5	Cooling . . . . .	87
3.3.2.6	Alignment and mechanical stability . . . . .	87
3.3.3	Layout . . . . .	88

---

---

3.3.3.1	The barrel detector . . . . .	88
3.3.3.2	The end-cap detector . . . . .	92
3.4	The Silicon Detectors . . . . .	93
3.4.1	Radiation resistance . . . . .	93
3.4.1.1	Surface damage . . . . .	93
3.4.1.2	Bulk damage . . . . .	94
3.4.2	Detector design considerations . . . . .	97
3.4.3	General detector specifications . . . . .	98
3.4.4	Sensor design . . . . .	100
3.4.5	Results on prototypes . . . . .	103
3.4.5.1	Breakdown protection . . . . .	108
3.4.6	Test beam results . . . . .	111
3.4.6.1	Signal to noise ratio . . . . .	111
3.4.6.2	Detector efficiency . . . . .	116
3.4.6.3	Response function and spatial resolution . . . . .	118
3.4.6.4	Data with low momentum particles . . . . .	121
3.4.7	Modeling of silicon micro-strip detectors . . . . .	122
3.5	The Read-Out System . . . . .	124
3.5.1	General architecture . . . . .	125
3.5.2	The front-end chips . . . . .	125
3.5.3	The front-end hybrids . . . . .	126
3.5.4	The FED and the optical link . . . . .	126
3.5.5	Expected performance . . . . .	127
3.6	The Detector Modules . . . . .	129
3.6.1	Requirements . . . . .	129
3.6.2	General layout and choice of materials . . . . .	129
3.6.3	Single-sided barrel modules . . . . .	130
3.6.4	Double-sided barrel modules . . . . .	131
3.6.5	Single-sided end-cap detector modules . . . . .	132
3.6.6	Double-sided end-cap detector modules . . . . .	133
3.6.7	Cooling performance of the detector modules . . . . .	134
3.6.8	The module construction . . . . .	138
3.6.8.1	Assembly procedure and jigs . . . . .	140
3.6.9	Quality control and tests . . . . .	144
3.7	The Support Structure . . . . .	145
3.7.1	General requirements and constraints . . . . .	145
3.7.2	General layout and choice of material . . . . .	145
3.7.3	The cooling system . . . . .	146
3.7.4	The barrel structure . . . . .	148
3.7.4.1	General layout . . . . .	148
3.7.4.2	Fabrication and assembly . . . . .	151
3.7.5	The end-cap structure . . . . .	153
3.7.5.1	General layout . . . . .	153
3.7.5.2	Supporting disks . . . . .	153
3.7.5.3	Cooling system . . . . .	156
3.7.5.4	Survey and test . . . . .	156
3.7.6	Access and maintenance procedure . . . . .	157
3.8	The Alignment System . . . . .	157
3.9	System Tests, Prototypes and Milestones . . . . .	158
3.9.1	SiB1 . . . . .	158

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3.9.1.1	Overview . . . . .	158
3.9.1.2	Support structure . . . . .	159
3.9.1.3	Fabrication of the CF wheel . . . . .	159
3.9.1.4	The cooling system . . . . .	159
3.9.1.5	Interconnect cards and cables . . . . .	160
3.9.1.6	Detector modules . . . . .	160
3.9.1.7	Production of the carbon fiber frames . . . . .	161
3.9.1.8	Module assembly . . . . .	161
3.9.1.9	Tests of the modules . . . . .	163
3.9.1.10	Wheel assembly . . . . .	163
3.9.2	SiF1 . . . . .	163
3.9.2.1	Overview . . . . .	163
3.9.2.2	Support structure . . . . .	165
3.9.2.3	Detector modules . . . . .	166
3.9.2.4	DAQ system . . . . .	167
3.9.2.5	Performance of the modules . . . . .	167
3.9.2.6	Performance of the cooling system . . . . .	168
<b>4</b>	<b>The MSGC Tracker</b>	<b>171</b>
4.1	Overview and Motivations . . . . .	171
4.2	Experimental Constraints, Layout and Specifications . . . . .	172
4.3	Detecting Elements: the Micro Strip Gas Chamber . . . . .	173
4.3.1	MSGC: principle of operation . . . . .	173
4.3.2	Basic detector properties and substrate characteristic . . . . .	175
4.3.2.1	Coating . . . . .	175
4.3.2.2	Metallisation . . . . .	177
4.3.2.3	Patterning . . . . .	177
4.3.2.4	Electric field configuration . . . . .	178
4.3.2.5	Advanced passivation . . . . .	180
4.3.2.6	Effect of a missing strip . . . . .	180
4.3.2.7	Signal cross-talk . . . . .	181
4.3.2.8	Choice of the gas mixture . . . . .	183
4.3.2.9	Performance prototype . . . . .	184
4.3.3	Tests related to the operating environment . . . . .	184
4.3.3.1	Charging-up effects . . . . .	184
4.3.3.2	Rate capability . . . . .	186
4.3.3.3	Ageing . . . . .	186
4.3.3.4	Response to heavily ionising particles and to high rates of charged hadrons . . . . .	187
4.3.3.5	Response to a fast neutron beam . . . . .	194
4.3.3.6	Response to low-energy neutrons . . . . .	195
4.3.3.7	Induced activation of MSGC material with thermal neutrons . . . . .	196
4.3.3.8	Summary of operation requirements and design criteria . . . . .	197
4.3.4	Detector performances for single track reconstruction . . . . .	198
4.3.4.1	Spatial resolution and track efficiency . . . . .	198
4.3.4.2	Behaviour in magnetic field . . . . .	200
4.3.4.3	Barrel MSGC: uniformity of response and edge effects . . . . .	202
4.3.4.4	Forward MSGC: uniformity of response and edge effects . . . . .	202
4.4	Barrel Mechanics . . . . .	205
4.4.1	Detecting elements . . . . .	209

---

---

4.4.1.1	Substrate specification . . . . .	209
4.4.1.2	Module layout . . . . .	213
4.4.1.3	FEA and the thermomechanical distortions . . . . .	215
4.4.2	Detector supporting elements . . . . .	215
4.4.2.1	The rod concept . . . . .	216
4.4.2.2	Layout of gas pipes and cables . . . . .	217
4.4.2.3	Cooling system and pipe layout . . . . .	218
4.4.2.4	FEA and mechanical behaviour . . . . .	219
4.4.3	The barrel wheel . . . . .	219
4.4.3.1	The wheel elements . . . . .	220
4.4.3.2	Rod positioning and fixing method . . . . .	222
4.4.3.3	Services layout . . . . .	223
4.4.3.4	Wheel support system . . . . .	224
4.4.3.5	FEA and expected distortion . . . . .	224
4.4.4	Propagation of mechanical distortions . . . . .	225
4.4.5	Experimental tests and prototype performances . . . . .	226
4.4.5.1	Cooling efficiency of the readout electronics system . . . . .	226
4.4.5.2	Mechanical precision under thermal cycling . . . . .	227
4.4.5.3	Experimental tests on coolant distribution . . . . .	227
4.4.5.4	Rod mechanical stability . . . . .	229
4.5	Forward Mechanics . . . . .	229
4.5.1	Detecting elements . . . . .	232
4.5.1.1	Substrate specification and dimension . . . . .	232
4.5.1.2	The detector modules . . . . .	233
4.5.1.3	The gas return system . . . . .	234
4.5.1.4	The twin chambers . . . . .	235
4.5.1.5	FEA and deformation studies . . . . .	235
4.5.2	The forward disk . . . . .	236
4.5.2.1	The mechanical layout . . . . .	236
4.5.2.2	FEA and mechanical distortion . . . . .	236
4.5.3	The services layout . . . . .	237
4.5.3.1	The cooling distribution . . . . .	238
4.5.3.2	The gas distribution . . . . .	239
4.6	Barrel MSGC Manufacturing and Assembly Sequence . . . . .	240
4.6.1	Detecting elements . . . . .	240
4.6.1.1	Module production and assembly procedure . . . . .	240
4.6.1.2	Quality control and acceptance test . . . . .	241
4.6.1.3	Final acceptance test . . . . .	241
4.6.2	Detector supporting elements . . . . .	242
4.6.2.1	Rod production and assembly procedure . . . . .	242
4.6.2.2	Mechanical precision acceptance tests . . . . .	243
4.6.2.3	Assembly of the module on the rod . . . . .	243
4.6.3	The barrel wheel . . . . .	245
4.6.3.1	Disk manufacture and assembly . . . . .	245
4.6.3.2	Cylinder and panel manufacture . . . . .	246
4.6.3.3	Wheel assembly . . . . .	247
4.6.3.4	Rod installation and alignment . . . . .	248
4.7	Forward MSGC Manufacturing and Assembly Sequence . . . . .	249
4.7.1	Detecting elements . . . . .	249
4.7.1.1	Substrate production . . . . .	249

---

---

4.7.1.2	Quality control and acceptance tests . . . . .	249
4.7.2	The detector module . . . . .	250
4.7.2.1	Production of mechanical elements . . . . .	250
4.7.2.2	Substrate positioning system and tooling . . . . .	250
4.7.2.3	Positioning quality control . . . . .	251
4.7.2.4	Final detector module assembly procedure . . . . .	253
4.7.2.5	Final testing procedure of detector module . . . . .	254
4.7.2.6	Assembly of detector modules on the disk . . . . .	254
4.7.3	The forward disk . . . . .	255
4.7.3.1	Manufacturing and assembly . . . . .	255
4.7.3.2	Final assembly into a super-module . . . . .	256
4.8	From the TDR to the Beginning of Construction . . . . .	257
4.9	Further Thoughts and Improvements . . . . .	257
<b>5</b>	<b>Microstrip Tracker Electronics</b>	<b>261</b>
5.1	Overview and Requirements . . . . .	261
5.1.1	Organisation . . . . .	262
5.1.2	Motivation for analog data . . . . .	262
5.1.3	System summary . . . . .	263
5.2	Radiation Hardness . . . . .	265
5.2.1	Technology issues . . . . .	267
5.2.2	Testing and qualification . . . . .	268
5.2.3	Purchasing . . . . .	268
5.3	Front-End Electronics . . . . .	269
5.3.1	Silicon front-end chip . . . . .	269
5.3.2	APV6 . . . . .	269
5.3.2.1	Analog stages . . . . .	269
5.3.2.2	Control interface . . . . .	270
5.3.2.3	Error conditions . . . . .	271
5.3.2.4	Operation . . . . .	272
5.3.2.5	Output data stream . . . . .	272
5.3.2.6	Calibration . . . . .	272
5.3.2.7	Analog performance . . . . .	273
5.3.2.8	Radiation tolerance . . . . .	275
5.3.3	Modifications for APVD . . . . .	277
5.3.3.1	Amplifier . . . . .	277
5.3.3.2	Logic and control . . . . .	277
5.3.3.3	Final assembly . . . . .	278
5.3.3.4	Results . . . . .	278
5.3.3.5	Radiation damage studies of DMILL . . . . .	278
5.3.4	MSGC front-end chip . . . . .	279
5.3.5	APVMUX . . . . .	280
5.3.6	Front-end hybrid . . . . .	281
5.4	Optical Link . . . . .	282
5.4.1	System description . . . . .	284
5.4.2	Components . . . . .	285
5.4.2.1	Electronics . . . . .	285
5.4.2.2	Optoelectronics . . . . .	287
5.4.2.3	Optical fibre, cables and connectors . . . . .	287
5.4.3	Experimental results . . . . .	288

---

---

5.4.3.1	Analog link . . . . .	288
5.4.3.2	Digital link . . . . .	288
5.4.4	Radiation hardness . . . . .	289
5.4.4.1	Lasers . . . . .	290
5.4.4.2	P-i-n photodiodes . . . . .	291
5.4.4.3	Fibres and connectors . . . . .	292
5.5	Front-End Driver . . . . .	292
5.5.1	Introduction . . . . .	293
5.5.1.1	Optical input stage . . . . .	293
5.5.1.2	ADC and Digital Signal Processing . . . . .	293
5.5.1.3	Output . . . . .	296
5.5.2	Interfaces . . . . .	298
5.5.2.1	DAQ interface . . . . .	298
5.5.2.2	FED and RDPM interface . . . . .	299
5.5.2.3	Computer system interface . . . . .	299
5.5.2.4	Trigger, timing and command interface . . . . .	299
5.5.3	System aspects . . . . .	300
5.5.4	DAQ . . . . .	300
5.5.4.1	Data formats . . . . .	300
5.5.4.2	Event sizes and rates . . . . .	301
5.5.5	Development time-scale . . . . .	302
5.6	Control and Monitoring . . . . .	303
5.6.1	Overview of CMS Tracker control system . . . . .	303
5.6.2	Communication architecture . . . . .	305
5.6.3	Token-ring protocol . . . . .	306
5.6.4	Data encoding . . . . .	307
5.6.5	Redundancy specifications . . . . .	308
5.6.6	System components . . . . .	308
5.6.6.1	Communication and control unit . . . . .	308
5.6.6.2	Phase Locked Loop chip . . . . .	309
5.6.6.3	CCUM . . . . .	310
5.6.6.4	Front-End Controller . . . . .	311
5.6.7	CMS controls and monitoring . . . . .	312
5.6.7.1	DCS overview . . . . .	312
5.6.7.2	Controls software system . . . . .	313
5.6.8	Control system integration . . . . .	314
5.7	Low-Voltage Power Supply . . . . .	314
5.7.1	Overview . . . . .	314
5.7.2	General requirements . . . . .	315
5.7.3	Constraints: magnetic field, radiation background, cable cooling . . . . .	315
5.7.4	Other constraints: EMC, cable bulk . . . . .	316
5.8	High-Voltage Power Supply . . . . .	316
5.8.1	MSGC drift HV and silicon bias voltage power supplies . . . . .	317
5.8.2	MSGC cathode strip HV control . . . . .	317
5.8.2.1	Links to HV control . . . . .	318
5.9	System Operation . . . . .	319
5.9.1	Readout milestone . . . . .	319
5.9.2	Installation and initial operation . . . . .	322
5.9.2.1	Initialisation . . . . .	323
5.9.2.2	Synchronisation . . . . .	323

---

5.9.3	Operational performance . . . . .	323
5.9.3.1	Noise . . . . .	323
5.9.3.2	Calibration . . . . .	325
5.9.4	Long-term maintenance . . . . .	325
5.10	Schedule and Planning . . . . .	325
5.10.1	Front-end electronics . . . . .	326
5.10.2	Optical link . . . . .	326
5.10.3	Control system and DAQ . . . . .	326
<b>6</b>	<b>Engineering</b>	<b>329</b>
6.1	Overview . . . . .	329
6.2	Tracker Support Structures . . . . .	329
6.2.1	General requirements . . . . .	329
6.2.1.1	Definitions . . . . .	329
6.2.1.2	General task . . . . .	331
6.2.1.3	Overall dimensions . . . . .	331
6.2.1.4	Maximal length for installation . . . . .	331
6.2.2	Structural requirements . . . . .	331
6.2.2.1	Positioning precision . . . . .	331
6.2.2.2	Stability and vibrations . . . . .	331
6.2.3	Tracker-related operational requirements . . . . .	331
6.2.3.1	Operating temperatures and thermal separation . . . . .	331
6.2.3.2	Humidity control inside the cold volume . . . . .	332
6.2.3.3	Gas tightness of the MSGC volume . . . . .	332
6.2.3.4	Pixel detector independent installation and extraction . . . . .	332
6.2.3.5	Silicon detector maintenance . . . . .	332
6.2.3.6	Staging scenario . . . . .	332
6.2.3.7	Support and reference for the Tracker internal alignment system . . . . .	332
6.2.3.8	General maintenance schedule . . . . .	333
6.2.4	CMS-related operational requirements . . . . .	333
6.2.4.1	Beam pipe support . . . . .	333
6.2.4.2	<i>In situ</i> access to the beam pipe . . . . .	333
6.2.4.3	ECAL barrel interface . . . . .	333
6.2.4.4	ECAL endcap interface . . . . .	333
6.2.4.5	HCAL barrel interface . . . . .	334
6.2.4.6	Muon detector interface . . . . .	334
6.2.5	Design guidelines . . . . .	334
6.2.5.1	General principles . . . . .	334
6.2.5.2	Static loads and deflection . . . . .	334
6.2.5.3	Dynamic properties and constraints . . . . .	335
6.2.6	Structural materials . . . . .	335
6.2.6.1	Environmental conditions . . . . .	335
6.2.6.2	Basic requirements for structural materials . . . . .	336
6.2.6.3	Material options . . . . .	337
6.2.6.4	Conclusions . . . . .	339
6.2.7	The central support tube . . . . .	339
6.2.7.1	General concept . . . . .	339
6.2.7.2	Loads and constraints . . . . .	340
6.2.7.3	Finite Element Analysis (F.E.A.) . . . . .	341
6.2.7.4	Results . . . . .	341

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---

6.2.8	The endflanges . . . . .	341
6.2.9	Tracker support brackets . . . . .	342
6.2.9.1	General concept . . . . .	342
6.2.9.2	Finite element analysis . . . . .	343
6.2.10	Beam pipe and Pixel detector support . . . . .	343
6.2.10.1	General characteristics . . . . .	343
6.2.10.2	The inner support . . . . .	345
6.2.10.3	The intermediate support . . . . .	346
6.2.10.4	The outer support . . . . .	346
6.3	General Tracker Services . . . . .	346
6.3.1	Overview . . . . .	346
6.3.2	Cabling . . . . .	347
6.3.3	Cooling . . . . .	349
6.3.3.1	Pixel cooling system . . . . .	350
6.3.3.2	Silicon cooling system . . . . .	352
6.3.3.3	MSGC cooling system . . . . .	353
6.3.4	Optical readout . . . . .	355
6.3.5	MSGC gas system . . . . .	355
6.3.6	Dry nitrogen gas system . . . . .	362
6.3.7	Slow controls . . . . .	362
6.3.7.1	General remarks . . . . .	362
6.3.7.2	Slow control for the Pixel and Silicon detectors . . . . .	363
6.3.7.3	Slow control for the MSGC detector . . . . .	364
6.4	Thermal Screen Between Cold and Warm Volumes . . . . .	366
6.4.1	Requirements . . . . .	366
6.4.2	Global thermal load . . . . .	367
6.4.3	Possible solutions . . . . .	367
6.4.4	Technical solutions . . . . .	368
6.4.5	F.E.A. model . . . . .	369
6.4.6	Results and discussion . . . . .	370
6.5	Alignment . . . . .	372
6.5.1	Requirements . . . . .	373
6.5.2	Alignment procedure . . . . .	373
6.5.2.1	Initial survey . . . . .	373
6.5.2.2	Position monitoring after installation . . . . .	374
6.5.3	Techniques . . . . .	374
6.5.3.1	Digital photogrammetry for survey . . . . .	375
6.5.3.2	Lensless straightness measurement system for online monitoring . . . . .	376
6.5.3.3	Global layout . . . . .	380
6.5.3.4	The alignment wheel . . . . .	381
6.5.3.5	Expected performance of the position monitoring system . . . . .	382
6.5.4	Link to the Muon system . . . . .	383
6.5.5	Engineering and system aspects . . . . .	385
6.5.5.1	The alignment wheel . . . . .	385
6.5.5.2	Alignment channels layout . . . . .	391
6.5.5.3	Electronics and readout . . . . .	391
6.5.6	Laboratory tests . . . . .	391
6.5.6.1	Full scale test with the Muon alignment system . . . . .	391
6.5.7	Other techniques under evaluation . . . . .	392
6.5.7.1	$z$ -coordinate measurement . . . . .	392

---

---

6.5.7.2	Other 2D light detection mechanisms . . . . .	393
6.5.7.3	Use of transparent Silicon detectors for the Tracker alignment . . . . .	393
6.5.7.4	Straightness measurement with a stretched wire . . . . .	394
6.6	CMS Proposal for the Beam Pipe . . . . .	394
6.7	Tracker Assembly and Installation . . . . .	395
6.7.1	Assembly hall . . . . .	395
6.7.2	General MSGC installation procedure . . . . .	396
6.7.3	General Silicon installation procedure . . . . .	398
6.7.4	Tracker installation procedure . . . . .	399
6.7.5	Beam pipe installation procedure . . . . .	401
6.7.6	Completion of the installation procedure . . . . .	401
6.7.7	Tracker installation planning . . . . .	402
6.7.7.1	Global schedule . . . . .	402
6.7.7.2	Initial installation . . . . .	402
6.8	Tracker Maintenance . . . . .	402
6.8.1	Access time-scales . . . . .	402
6.8.2	Maintenance hall . . . . .	403
6.9	Safety . . . . .	404
6.9.1	Safety Objectives . . . . .	404
6.9.2	Mechanical aspects . . . . .	405
6.9.3	Electricity and electronics . . . . .	406
6.9.4	Cooling systems . . . . .	408
6.9.5	Gases . . . . .	408
6.9.6	Fire protection . . . . .	408
6.9.7	Lasers for alignment . . . . .	409
6.9.8	Estimate of induced radioactivity . . . . .	409
6.9.8.1	Induced activity in the ECAL . . . . .	410
6.9.8.2	Induced activity in the Tracker . . . . .	410
6.9.9	Personal safety, access and egress . . . . .	416
<b>7</b>	<b>Simulation</b> . . . . .	<b>417</b>
7.1	Overview . . . . .	417
7.2	Software . . . . .	417
7.3	Magnetic Field . . . . .	418
7.4	Beam Pipe . . . . .	419
7.5	Detector Layout . . . . .	420
7.5.1	Phase II CMS Tracker . . . . .	420
7.5.2	Rapidity coverage and hermeticity . . . . .	421
7.5.3	Phase I CMS Tracker . . . . .	425
7.6	Supports and Services . . . . .	426
7.6.1	Support structures . . . . .	426
7.6.2	Services . . . . .	430
7.7	Tracker material budget . . . . .	434
7.7.1	Sensitive volumes . . . . .	435
7.7.2	Electronics . . . . .	435
7.7.3	Support structures . . . . .	438
7.7.4	Cables . . . . .	439
7.7.5	Cooling . . . . .	439
7.7.6	Total number of radiation lengths . . . . .	441
7.7.7	Total number of interaction lengths . . . . .	442

---

---

7.8	Pixel detector . . . . .	444
7.8.1	Readout configuration . . . . .	444
7.8.2	Simulation of signal and noise . . . . .	445
7.8.3	Digitisation and cluster reconstruction . . . . .	446
7.8.4	Spatial resolution and efficiency . . . . .	447
7.8.5	Comparison with test beam measurements . . . . .	447
7.9	Si-strip Detector . . . . .	448
7.9.1	Readout configuration . . . . .	448
7.9.2	Simulation of signal and noise . . . . .	448
7.9.3	Digitisation and cluster reconstruction . . . . .	450
7.9.4	Spatial resolution and efficiency . . . . .	451
7.10	MSGC detector . . . . .	453
7.10.1	Readout configuration . . . . .	453
7.10.2	Simulation of signal and noise . . . . .	453
7.10.3	Digitisation and cluster reconstruction . . . . .	456
7.10.4	Spatial resolution and efficiency . . . . .	459
7.11	Occupancy . . . . .	460
7.11.1	Pixel occupancy . . . . .	461
7.11.2	Strip detector occupancy . . . . .	462
7.11.2.1	Kinematics occupancy . . . . .	462
7.11.2.2	Detector occupancy . . . . .	463
7.11.2.3	Cluster merging . . . . .	466
7.11.2.4	Cluster splitting . . . . .	466
<b>8</b>	<b>Reconstruction</b>	<b>467</b>
8.1	Pattern recognition and track reconstruction . . . . .	467
8.1.1	Global Track Finder . . . . .	468
8.1.2	Connection Machine . . . . .	468
8.1.3	Forward Kalman Filter . . . . .	469
8.2	Vertex reconstruction . . . . .	470
8.2.1	PVF algorithm . . . . .	470
8.2.2	GVF algorithm . . . . .	471
8.2.2.1	Initialisation . . . . .	471
8.2.2.2	Deformable templates algorithm . . . . .	471
8.3	Calibration with reconstructed tracks . . . . .	472
8.3.1	Calibration precision requirements . . . . .	473
8.3.2	Simulation study for requirements . . . . .	473
8.3.3	Calibration strategies . . . . .	475
<b>9</b>	<b>Performance</b>	<b>477</b>
9.1	Overview . . . . .	477
9.2	Physics Simulation . . . . .	478
9.2.1	Single tracks . . . . .	478
9.2.2	Minimum bias events . . . . .	478
9.2.3	B-meson decay events . . . . .	479
9.2.4	Di-jet events . . . . .	479
9.3	Single Track Performance . . . . .	480
9.3.1	Impact parameter resolution . . . . .	481
9.3.2	Transverse momentum resolution . . . . .	483
9.3.3	Angular resolution . . . . .	483

---

---

9.3.4	Track finding efficiency . . . . .	483
9.3.5	Charge assignment efficiency . . . . .	485
9.3.6	Tails of distributions . . . . .	486
9.3.7	Effect of pile-up . . . . .	487
9.4	Isolated Tracks . . . . .	488
9.4.1	Electron reconstruction . . . . .	488
9.4.1.1	Bremsstrahlung recovery method . . . . .	490
9.4.1.2	Performance . . . . .	491
9.4.2	Hadron reconstruction . . . . .	494
9.4.2.1	Definition of efficiency . . . . .	494
9.4.2.2	Performance . . . . .	495
9.4.2.3	Tails of distributions . . . . .	497
9.5	Tracks in Jets . . . . .	498
9.5.1	Occupancy inside high $p_T$ jets . . . . .	498
9.5.1.1	Cluster quality . . . . .	498
9.5.2	Track finding performance . . . . .	500
9.6	Vertex Reconstruction . . . . .	502
9.6.1	Primary vertices . . . . .	502
9.6.2	$V^0$ vertices . . . . .	504
9.6.2.1	Reconstruction of converted photons . . . . .	504
9.6.2.2	$K_S^0$ reconstruction . . . . .	505
9.6.3	Reconstruction of $B \rightarrow J/\psi K_S$ . . . . .	506
9.7	Heavy Flavour Identification . . . . .	507
9.7.1	Impact Parameter tagging . . . . .	509
9.7.2	B-tagging with 3D vertex reconstruction . . . . .	510
9.8	Heavy Ion Physics . . . . .	514
9.8.1	Introduction . . . . .	514
9.8.2	Reconstruction method . . . . .	514
9.8.3	Identification of $\Upsilon \rightarrow \mu\mu$ events in AA interactions . . . . .	515
9.9	Summary of CMS Tracker Performance . . . . .	517
<b>10</b>	<b>Project Organisation, Responsibilities, Costs and Planning</b>	<b>519</b>
10.1	Participating Institutes . . . . .	519
10.2	Project Organisation . . . . .	522
10.3	Costs and Funding . . . . .	524
10.4	Institutional Responsibilities . . . . .	524
10.5	Organisation of Construction . . . . .	530
10.5.1	Pixel Detector Construction . . . . .	530
10.5.2	Si-Strip Tracker Construction . . . . .	530
10.5.3	MSGC Tracker Construction . . . . .	531
10.5.3.1	Barrel MSGC Construction . . . . .	532
10.5.3.2	Forward–Backward MSGC Construction . . . . .	533
10.5.4	Readout and Control Electronics . . . . .	533
10.6	Construction schedule and Planning . . . . .	534
<b>A</b>	<b>Radiation Environment</b>	<b>A.1</b>
A.1	General Features of the Radiation Environment . . . . .	A.1
A.2	Definitions of Radiation Units . . . . .	A.1
A.3	Radiation Damage in Silicon . . . . .	A.2
A.3.1	Surface damage . . . . .	A.2

---

---

A.3.2	Bulk damage . . . . .	A.2
A.4	Shielding Requirements and Materials . . . . .	A.3
A.5	LHC Parameters . . . . .	A.4
A.5.1	Luminosity . . . . .	A.4
A.5.2	Assumed operation schedule . . . . .	A.5
A.6	Induced Radioactivity . . . . .	A.5
A.7	Simulation Methods . . . . .	A.6
A.7.1	Generation of minimum bias events . . . . .	A.6
A.7.2	Radiation transport codes . . . . .	A.7
A.7.3	General geometry description . . . . .	A.8
A.7.4	Energy cuts and transport parameters . . . . .	A.8
A.7.5	Scoring . . . . .	A.9
A.7.6	Estimation of error margins . . . . .	A.9
A.7.7	Simulation of LHC beam losses . . . . .	A.10
A.7.8	Estimation of induced radioactivity . . . . .	A.11
A.8	Pixel Detector . . . . .	A.11
A.9	Silicon Tracker . . . . .	A.14
A.10	MSGC Tracker . . . . .	A.16
A.10.1	Highly ionizing particle rates . . . . .	A.18
A.11	Alignment System . . . . .	A.19
A.12	Beam Loss Related Contribution . . . . .	A.20
A.13	Detector Background Due to Induced Radioactivity . . . . .	A.21

**B Acronyms and Abbreviations**

**B.1**